



SmartAnythingEverywhere



European Initiative
Smart Anything Everywhere



SAE Collaboration Meeting
April 2nd 2020, Online



Open Call Alignment

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Smart4Europe2 has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No. 872111.

Ideas for Open Call Alignment



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- ▶ Promote Open Calls on EC and SAE Portal
- ▶ <https://ec.europa.eu/digital-single-market/en/news/digital-innovation-hubs-projects-open-calls-smes>
- ▶ <https://ec.europa.eu/info/funding-tenders/opportunities/portal/screen/opportunities/competitive-calls>
- ▶ <https://smartanythingeverywhere.eu/>

Please be proactive in providing info to the EC and CSA



Ideas for Open Call Alignment



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(Version 16072019)

TEMPLATE for FP7 Competitive Calls and H2020 Financial Support to Third Parties

To publish a call on the Funding & Tenders Portal (F&TP), the Project Officer must send to the F&TP team at least the following information:



	Information to be provided by the project consortium
Call title:	
Full name of the EU funded project:	
Project acronym:	
Grant agreement number:	
Call publication date:	
Call deadline:	
Expected duration of participation:	
Total EU funding available:	
Submission & evaluation process:	
Further information:	
Task description:	

Additional information may also be required/presented:

Funding scheme/type of action, thematic priority, contract type, project status, project/research costs and funding, eligibility requirements, evaluation criteria, proposal format, project coordinator...

► Provide open call website

DigiFed

Open call for Application Experiment (AE): DigiFed offers grants of up to € 55k as well as technical and business support for the development of smart applications in Europe.

First call is currently open. Apply until June 9th 2020.

Details in open calls can be found here: <https://digifed.org/explore/open-calls/>

SmartEEs2

SmartEEs2 Call for integration of flexible and wearable electronics technologies is now open!

Details can be found at <https://smartees.eu/smartees2-call-for-integration-of-flexible-and-wearable-electronics-technologies-is-now-open/>



Details on Open Calls (2020)



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IA	Date Opening-Closure	Funding amount per Partner	Organisation type eligible for Funding	Single Company or Consortium	Technology
BOWI	1st call: 08/06/20- 15/09/20	75k€	-Small and medium sized enterprises -midcaps (<3000 employees)	Single company	All S4E/I4MS technologies
DigiFed	1st call: 17/03/20- 09/06/20	55k€	-Start-ups -Small and medium sized enterprises -midcaps (<3000 employees)	Consortium: -Single AE (1 company, 3 partners) -Twin AE (2 companies from different countries, 3 partners)	CPS and embedded systems
	2nd call: 09/20–N/A	N/A	N/A	N/A	CPS and ES
DIH4CPS	1st call: 01/04/20- 31/08/20	180k€	Not Specified	Mini consortia (at least one DIH currently enrolled in the EC DIH Catalogue)	CPS and ES
HUBCAP	PULL Calls 4/20-5/20 11/20-12/20	1k€	Start-ups, SMEs, Mid-caps, RTOs	Single Company	CPS
	EXPERIMENT Call 11/20-1/21	30-75k€ (max 60k per partner)	SMES MBD CPS providers (from HUBCAP ecosystem) SMEs MBD CPS users/adopters	Consortia of 2 SMEs	MBD CPS Products and services



Details on Open Calls (2020)



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IA	Date Opening-Closure	Funding amount per Partner	Organisation type eligible for Funding	Single Company or Consortium	Technology
TETRAMAX	4th Call: 31/01/20- 30/04/20	50k€	Industrial entities (SMEs/midcaps/large industry) and Academic Institutions	Consortium (One academic and one industry partner)	CLEC and IOT
SMART4ALL	1st call: 15/04/20- 15/07/20 (may be extended)	8k€	Industrial entities (SMEs/Slightly Bigger Companies), Academic Institutions, System integrators	Consortium (2 partners, 1 Industrial leader compulsory)	CLEC
	2nd call: 30/06/20- 30/09/20 (may be extended)	80k€	Industrial entities (SMEs/Slightly Bigger Companies), Academic Institutions, System integrators	Consortium (1-3 partners, 1 Industrial leader compulsory)	CLEC
	3rd call: 01/12/20- 01/03/21	80k€	Industrial entities (SMEs/Slightly Bigger Companies), Academic Institutions, System Integrators	Consortium (3 partners, 1 Industrial leader compulsory)	CLEC
SmartEes2	1st call open: 03/20 Cut-off: -05/06/20 -23/09/20 -more in 21	100k€	-SMEs and midcaps -Tech (innovative companies) or non-tech (traditional industries) -From all activities fields	Single company	FWE





- ▶ Synergies in terms of same topics (e.g. CPS)
- ▶ Synergies in terms of same application domains (health, manufacturing)
- ▶ Complementarities



Complementary opportunities



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IA	Sub-Tech	Application domain
BOWI	Not explicitly specified	Low energy computing powering CPS, Cyber-physical and embedded systems, Advanced or High- performance computing, Laser based manufacturing, Internet of things, Organic and Large Area Electronics, Robotics for manufacturing, CPS for manufacturing, Flexible and Wearable Electronics ,Man/machine interfaces, Additive manufacturing technologies, Cloud computing, Modelling and simulation
DigiFed	Smart applications; AI; Connectivity/IoT; Additive manufacturing; Application-specific; semiconductor technologies; Heterogeneous integration and smart miniaturized systems; Micro and nano bio-systems; The energy efficiency of systems	-CPS Software-intensive project: Building a system solution using existing programmable CPS software core platforms. -System integration project: Building a system solution using existing SW and HW components.
DIH4CPS	Not explicitly specified	Not explicitly specified
HUBCAP	MBD: models and tools	Open, e.g., Production, Transport, Robotics, Sensors, Space, Semiconductors, power systems, Avionics (...)
Tetramax	Many	Many
Smart4All	CPS and IoT	Digitized Transport; Digitized Environment; Digitized Agriculture; Digitized Anything
SmartEes2	Electronics Printing; High volume component assembly; Post-processing/Finishing; Structural electronics	OLED lighting; Organic photovoltaics; Flexible displays; Electronics and components; Integrated smart systems; Smart textiles; Structural electronics





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- ▶ Cross-promotion of open calls by IAs, CSA, EC and sister initiatives (I4MS, DIHNET)
- ▶ Joint promotion/outreach events
- ▶ EC and CSA events (conferences, fairs, brokerages)
- ▶ Other ideas?





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Thank you for your attention!



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